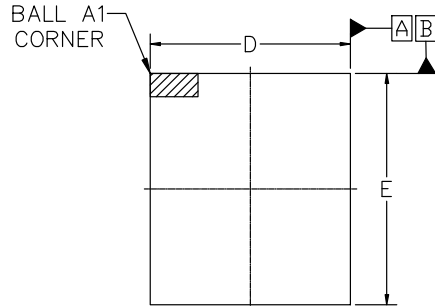
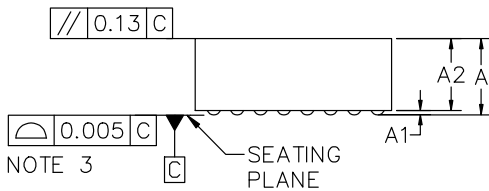


SIP52 4.58x3.86x1.42, 0.46P
CASE 127EV
ISSUE O

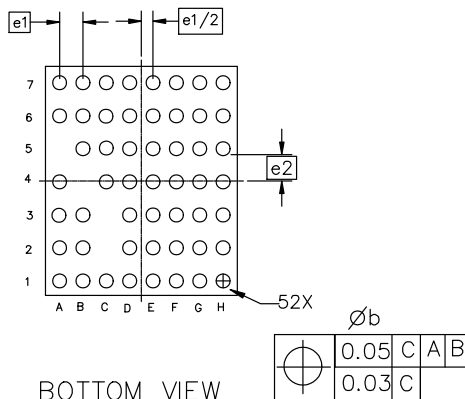
DATE 14 APR 2025



TOP VIEW



SIDE VIEW

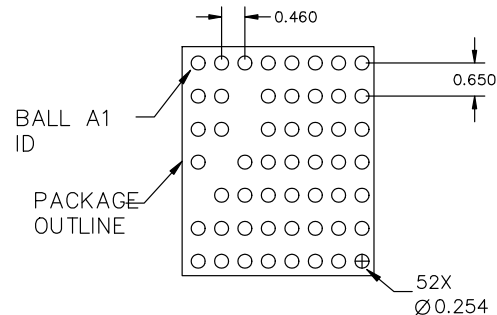


BOTTOM VIEW

NOTES:

1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M, 2018.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	----	----	1.520
A1	0.060	0.080	.100
A2	1.320	1.370	1.420
b	0.204	0.254	0.304
D	3.780	3.860	3.940
E	4.500	4.580	4.660
e1	0.460 BSC		
e2	0.650 BSC		



RECOMMENDED MOUNTING FOOTPRINT

*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	SIP52 4.58x3.86x1.42, 0.46P	PAGE 1 OF 1

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